

REMARKS

Amendment summary

Claim 1 is amended for purposes of antecedent basis.

No new matter is added by this Amendment, and Applicants respectfully request entry of the Amendment.

Status of the claims

Claim 1 has been rejected under 35 U.S.C. § 112 as allegedly being indefinite. In addition, Claims 1 and 2 have been rejected under 35 U.S.C. §103(a) as allegedly being unpatentable over Tanimoto et al. (JP 05-226372) in view of Kuroda et al. (U.S. Patent No. 5,831,296) (hereinafter “Tanimoto” and “Kuroda,” respectively).

Response to rejection under 35 U.S.C. § 112

Claim 1 has been rejected under 35 U.S.C. § 112 as allegedly being indefinite. In particular, the Examiner asserted that the phrase "wherein said undoped GaAs layer" did not have antecedent basis. Applicants note that Claim 1 has been amended, and respectfully submits that this rejection is therefore moot.

Response to rejection based on Tanimoto in view of Kuroda

Claims 1 and 2 have been rejected under 35 U.S.C. §103(a) as allegedly being unpatentable over Tanimoto in view of Kuroda. Applicants respectfully submit that the presently claimed invention is not rendered obvious by the cited references because, contrary to the

position set forth in the Office Action, the teachings of Kuroda do not indicate that the semiconductor layer in Tanimoto would have the mobility presently claimed.

The present claims recite a compound semiconductor epitaxial substrate for use in a strain channel high electron mobility field effect transistor, comprising an InGaAs layer as a strain channel layer and an AlGaAs layer containing n-type impurities as an electron supplying layer, wherein said InGaAs layer has an electron mobility at room temperature of $8300\text{ cm}^2/\text{V}\cdot\text{s}$ or more. In addition, undoped GaAs layers having a thickness of 4 nm or more each are laminated respectively in contact with a top surface and a bottom surface of the strain channel layer and at least one of the undoped GaAs layers is further in contact with an undoped AlGaAs layer. Also, the AlGaAs layer containing n-type impurities is in contact with the undoped AlGaAs layer.

Applicants respectfully traverse the Office Action's position that the teachings of Kuroda indicate that the semiconductor layer in Tanimoto would have the electron mobility presently claimed.

Mr. Osada's Declaration under 37 C.F.R. § 1.132, attached to this Amendment, explains Applicants' position. In particular, Mr. Osada notes that a person having ordinary skill in the art would understand that the high electron mobility transistor (HEMT) in Kuroda is not the same HEMT disclosed in Tanimoto, and would therefore possess distinct properties. Thus, according to Mr. Osada, a person having ordinary skill in the art would thus understand that the electron mobility reported in Kuroda's HEMT would not be applicable to the HEMT in Tanimoto. The reason is that Kuroda discloses a HEMT, whereas Tanimoto discloses a strain channel HEMT (to which the presently claimed invention relates). A strain channel HEMT has a strain channel

layer that is formed by growing a material on a substrate such as GaAs. The material has a different lattice constant from the substrate, but maintains its crystal structure.

Mr. Osada explains that this is relevant because the electron mobility of the GaAs layer in the GaAs (strain) channel HEMT in Tanimoto is about $8000 \text{ cm}^2/\text{Vsec}$ (as described by Tanimoto in Paragraph No. [0004]), whereas the electron mobility of the GaAs layer in the (non-strain) HEMT of Kuroda is $8500 \text{ cm}^2/\text{Vsec}$. In Mr. Osada's opinion, a person having ordinary skill in the art would not understand from these two references that the strain channel HEMT in Tanimoto would have the electron mobility shown in the non-strain channel of Kuroda. Accordingly, the teachings of Kuroda fail to indicate that the semiconductor layer in Tanimoto would have the electron mobility presently claimed.

With respect to the characterization of Tanimoto in the Office Action, Applicants respectfully submit that Fig. 6 in Tanimoto does not disclose that undoped GaAs layers [2] and [4] have a thickness of 2 to 4 nm. Instead, Tanimoto in paragraph [0004] states that:

"For example, when spacer layer width is not less than 20 nm in the case of GaAs channel layer HEMT, electron mobility becomes about $8000 \text{ cm}^2/\text{Vsec}$, the maximum value that is attainable by GaAs. However, if spacer layer width is too large, the number of carries produced in a channel will decrease and as a result mutual conductance will also decrease. Usually, the optimum value of spacer layer width was about 2 to 4 nm, at which the electron mobility was $5000 \text{ cm}^2/\text{Vsec}$."

Mr. Osada explains that Paragraph No. [0004] in Tanimoto only explains the defects or problems that exist in the prior art and which need to be solved. This passage does not relate to the undoped GaAs layers [2] and [4] in Fig. 6 of Tanimoto. Additionally, Mr. Osada asserts that Tanimoto does not disclose or suggest that the teaching of the spacer layer width provided by the

prior art can be applied to the invention within Tanimoto. In fact, this paragraph indicates that when the spacer layer width is as disclosed in the prior art, the electron mobility will be outside of the presently claimed range.

Therefore, Applicants respectfully submit that the presently claimed invention is not rendered obvious by the cited references, and Applicants respectfully request the reconsideration and withdrawal of this rejection.

Conclusion

In view of the above, reconsideration and allowance of this application are now believed to be in order, and such actions are hereby solicited. If any points remain in issue which the Examiner feels may be best resolved through a personal or telephone interview, the Examiner is kindly requested to contact the undersigned at the telephone number listed below.

The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account.

Respectfully submitted,

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